#### 1. **General description**

The 74HC30; 74HCT30 is an 8-input NAND gate. Inputs include clamp diodes. This enables the use of current limiting resistors to interface inputs to voltages in excess of V<sub>CC</sub>.

#### **Features and benefits** 2.

- Complies with JEDEC standard JESD7A
- Input levels:
  - For 74HC30: CMOS level
  - For 74HCT30: TTL level
- ESD protection:
  - HBM JESD22-A114F exceeds 2000 V
  - MM JESD22-A115-A exceeds 200 V
- Multiple package options
- Specified from -40 °C to +85 °C and from -40 °C to +125 °C

#### **Ordering information** 3.

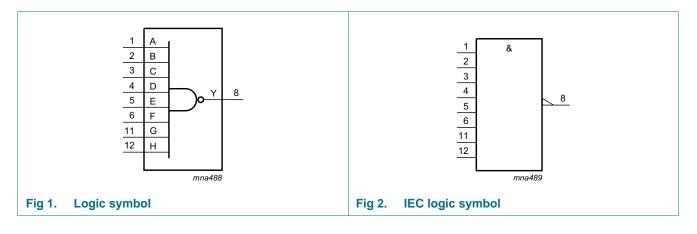
#### Table 1. **Ordering information**

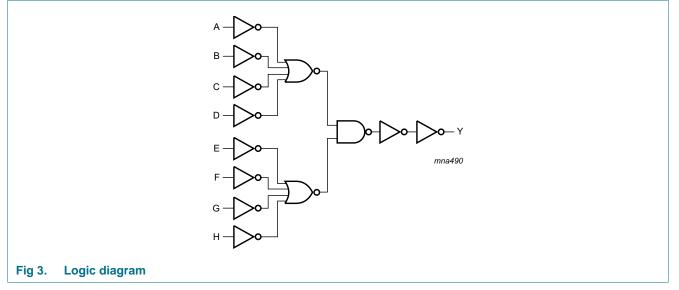
Type number	Package						
	Temperature range	Name	Description	Version			
74HC30D	–40 °C to +125 °C	SO14	plastic small outline package; 14 leads;	SOT108-1			
74HCT30D			body width 3.9 mm				
74HC30DB	–40 °C to +125 °C	SSOP14	plastic shrink small outline package; 14 leads; body	SOT337-1			
74HCT30DB			width 5.3 mm				
74HC30PW	–40 °C to +125 °C	TSSOP14	plastic thin shrink small outline package; 14 leads;	SOT402-1			
74HCT30PW			body width 4.4 mm				



8-input NAND gate

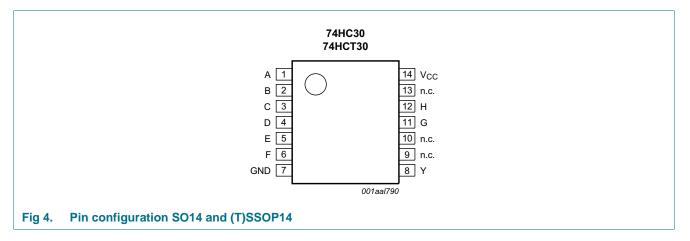
## 4. Functional diagram





## 5. Pinning information

### 5.1 Pinning



## 5.2 Pin description

Symbol	Pin	Description
A	1	data input
В	2	data input
С	3	data input
D	4	data input
E	5	data input
F	6	data input
GND	7	ground (0 V)
Y	8	data output
n.c.	9	not connected
n.c.	10	not connected
G	11	data input
Н	12	data input
n.c.	13	not connected
V <sub>CC</sub>	14	supply voltage

### 6. Functional description

#### Table 3. Function table<sup>[1]</sup>

Input								Output
Α	В	C	D	E	F	G	Н	Y
L	Х	Х	Х	Х	Х	Х	Х	Н
Х	L	Х	Х	Х	Х	Х	Х	Н
Х	Х	L	Х	Х	Х	Х	Х	Н
Х	Х	Х	L	Х	Х	Х	Х	Н
Х	Х	Х	Х	L	Х	Х	Х	Н
Х	Х	Х	Х	Х	L	Х	Х	Н
Х	Х	Х	Х	Х	Х	L	Х	Н
Х	Х	Х	Х	Х	Х	Х	L	Н
Н	Н	Н	Н	Н	Н	Н	Н	L

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care.

## 7. Limiting values

#### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V <sub>CC</sub>	supply voltage			-0.5	+7	V
I <sub>IK</sub>	input clamping current	$V_{I}$ < -0.5 V or $V_{I}$ > $V_{CC}$ + 0.5 V	<u>[1]</u>	-	±20	mA
I <sub>OK</sub>	output clamping current	$V_{O}$ < -0.5 V or $V_{O}$ > $V_{CC}$ + 0.5 V	<u>[1]</u>	-	±20	mA
lo	output current	$-0.5 \text{ V} < \text{V}_{\text{O}} < \text{V}_{\text{CC}} + 0.5 \text{ V}$		-	±25	mA
I <sub>CC</sub>	supply current			-	50	mA
I <sub>GND</sub>	ground current			-50	-	mA
T <sub>stg</sub>	storage temperature			-65	+150	°C
P <sub>tot</sub>	total power dissipation	SO14, (T)SSOP14 packages	<u>[2]</u>	-	500	mW

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] For SO14 package: Ptot derates linearly with 8 mW/K above 70 °C.

For (T)SSOP14 packages: Ptot derates linearly with 5.5 mW/K above 60 °C.

## 8. Recommended operating conditions

#### Table 5. Recommended operating conditions

Voltages are referenced to GND (ground = 0 V)

Symbol	Parameter	Conditions		74HC30			74HCT30		
			Min	Тур	Max	Min	Тур	Max	
V <sub>CC</sub>	supply voltage		2.0	5.0	6.0	4.5	5.0	5.5	V
VI	input voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
Vo	output voltage		0	-	V <sub>CC</sub>	0	-	V <sub>CC</sub>	V
T <sub>amb</sub>	ambient temperature		-40	-	+125	-40	-	+125	°C
$\Delta t / \Delta V$	input transition rise and fall rate	$V_{CC} = 2.0 V$	-	-	625	-	-	-	ns/V
		$V_{CC} = 4.5 V$	-	1.67	139	-	1.67	139	ns/V
		$V_{CC} = 6.0 V$	-	-	83	-	-	-	ns/V

## 9. Static characteristics

#### Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions		25 °C		-40 °C te	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Мах	-
74HC30	I.		1	1			1	1	-	-1
VIH	HIGH-level	V <sub>CC</sub> = 2.0 V	1.5	1.2	-	1.5	-	1.5	-	V
	input voltage	V <sub>CC</sub> = 4.5 V	3.15	2.4	-	3.15	-	3.15	-	V
		V <sub>CC</sub> = 6.0 V	4.2	3.2	-	4.2	-	4.2	-	V
V <sub>IL</sub>	LOW-level	V <sub>CC</sub> = 2.0 V	-	0.8	0.5	-	0.5	-	0.5	V
	input voltage	V <sub>CC</sub> = 4.5 V	-	2.1	1.35	-	1.35	-	1.35	V
		V <sub>CC</sub> = 6.0 V	-	2.8	1.8	-	1.8	-	1.8	V
V <sub>OH</sub>		$V_{I} = V_{IH} \text{ or } V_{IL}$								
output voltage	$I_{O} = -20 \ \mu A; \ V_{CC} = 2.0 \ V$	1.9	2.0	-	1.9	-	1.9	-	V	
		$I_{O} = -20 \ \mu A; \ V_{CC} = 4.5 \ V$	4.4	4.5	-	4.4	-	4.4	-	V
		$I_{O} = -20 \ \mu A; \ V_{CC} = 6.0 \ V$	5.9	6.0	-	5.9	-	5.9	-	V
		$I_{O} = -4.0 \text{ mA}; V_{CC} = 4.5 \text{ V}$	3.98	4.32	-	3.84	-	3.7	-	V
		$I_{O}$ = -5.2 mA; $V_{CC}$ = 6.0 V	5.48	5.81	-	5.34	-	5.2	-	V
V <sub>OL</sub>	LOW-level	$V_I = V_{IH} \text{ or } V_{IL}$								
	output voltage	$I_{O} = 20 \ \mu A; \ V_{CC} = 2.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_O = 20 \ \mu\text{A}; \ V_{CC} = 4.5 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O} = 20 \ \mu A; \ V_{CC} = 6.0 \ V$	-	0	0.1	-	0.1	-	0.1	V
		$I_{O}$ = 4.0 mA; $V_{CC}$ = 4.5 V	-	0.15	0.26	-	0.33	-	0.4	V
		$I_{O} = 5.2 \text{ mA}; V_{CC} = 6.0 \text{ V}$	-	0.16	0.26	-	0.33	-	0.4	V
lı	input leakage current	$V_{I} = V_{CC} \text{ or } GND;$ $V_{CC} = 6.0 \text{ V}$	-	-	±0.1	-	±1	-	±1	μA
I <sub>CC</sub>	supply current		-	-	2.0	-	20	-	40	μA

8-input NAND gate

Symbol	Parameter	Conditions		25 °C		–40 °C t	o +85 °C	–40 °C to	o +125 °C	Unit
			Min	Тур	Max	Min	Max	Min	Max	
Cı	input capacitance		-	3.5	-	-	-	-	-	pF
74HCT3	0						1	1	1	
V <sub>IH</sub>	HIGH-level input voltage	$V_{CC}$ = 4.5 V to 5.5 V	2.0	1.6	-	2.0	-	2.0	-	V
V <sub>IL</sub>	LOW-level input voltage	$V_{CC} = 4.5 V \text{ to } 5.5 V$	-	1.2	0.8	-	0.8	-	0.8	V
V <sub>OH</sub>	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = -20 μA	4.4	4.5	-	4.4	-	4.4	-	V
		I <sub>O</sub> = -4.0 mA	3.98	4.32	-	3.84	-	3.7	-	V
V <sub>OL</sub>	LOW-level	$V_{I} = V_{IH} \text{ or } V_{IL}; V_{CC} = 4.5 \text{ V}$								
	output voltage	I <sub>O</sub> = 20 μA	-	0	0.1	-	0.1	-	0.1	V
		I <sub>O</sub> = 4.0 mA	-	0.15	0.26	-	0.33	-	0.4	V
I	input leakage current	$V_I = V_{CC}$ or GND; $V_{CC} = 5.5 V$	-	-	±0.1	-	±1	-	±1	μA
I <sub>CC</sub>	supply current		-	-	2.0	-	20	-	40	μA
ΔI <sub>CC</sub>	additional supply current	per input pin; $V_I = V_{CC} - 2.4 \text{ V}$ ; $I_O = 0 \text{ A}$ ; other inputs at $V_{CC}$ or GND; $V_{CC} = 4.5 \text{ V}$ to 5.5 V	-	60	216	-	275	-	294	μΑ
CI	input capacitance		-	3.5	-	-	-	-	-	pF

#### Static characteristics ... continued Table 6.

At recommended operating conditions; voltages are referenced to GND (ground = 0 V).

## **10.** Dynamic characteristics

#### Table 7. **Dynamic characteristics**

 $GND = 0 V; C_L = 50 pF;$  for test circuit see <u>Figure 6</u>.

Parameter	Conditions		25 °C			–40 °C to	Unit	
		Min	Тур	Max	Max (85 °C)	Max (125 °C)	_	
t <sub>pd</sub> propagation delay	A, B, C, D, E, F, G, H to Y; see <u>Figure 5</u>	<u>[1]</u>						
	$V_{CC} = 2.0 V$		-	41	130	165	195	ns
	$V_{CC} = 4.5 V$		-	15	26	33	39	ns
	$V_{CC} = 5.0 \text{ V}; \text{ C}_{L} = 15 \text{ pF}$		-	12	-	-	-	ns
	$V_{\rm CC} = 6.0 \ V$		-	12	22	28	33	ns
transition time	see <u>Figure 5</u>	[2]						
	$V_{CC} = 2.0 V$		-	19	75	95	110	ns
	V <sub>CC</sub> = 4.5 V		-	7	15	19	22	ns
	V <sub>CC</sub> = 6.0 V		-	6	13	16	19	ns
	propagation delay	$\label{eq:propagation delay} \begin{tabular}{lllllllllllllllllllllllllllllllllll$	$\label{eq:propagation delay} \begin{array}{ c c c } A, B, C, D, E, F, G, H \text{ to } Y; & [1]\\ \hline & \text{see Figure 5}\\ \hline & V_{CC} = 2.0 \ V\\ \hline & V_{CC} = 4.5 \ V\\ \hline & V_{CC} = 5.0 \ V; \ C_L = 15 \ pF\\ \hline & V_{CC} = 6.0 \ V\\ \hline & \text{transition time} \\ \hline & \begin{array}{ c c } & \text{see Figure 5}\\ \hline & V_{CC} = 2.0 \ V\\ \hline & V_{CC} = 2.0 \ V\\ \hline & V_{CC} = 4.5 \ V\\ \hline & V_{CC} = 4.5 \ V\\ \hline & \end{array} $	$\begin{tabular}{ c c c c } \hline \mbox{Min} \\ \hline \mbox{Min} \\ \hline \end{tabular} \\ \begin{tabular}{ c c c c } \hline \end{tabular} \\ propagation delay & A, B, C, D, E, F, G, H to Y; & [1] & & & & & & & & & & & & & & & & & & &$	$\begin{tabular}{ c c c c } \hline Min & Typ \\ \hline Typ \\ \hline Min & Typ \\ \hline Typ \\ \hline$	$\begin{tabular}{ c c c c c } \hline Min & Typ & Max \\ \hline V_{CC} = 2.0 V & -112 & 22 \\ \hline V_{CC} = 4.5 V & -12 & -12 & 22 \\ \hline V_{CC} = 4.5 V & -112 & -12 & 22 \\ \hline Min & Typ & T5 \\ \hline V_{CC} = 4.5 V & -112 & 7 \\ \hline Min & Typ & T5 \\ \hline Min & Typ & Max \\ \hline Min & Typ & T5 \\ \hline V_{CC} = 4.5 V & -112 & -12 \\ \hline Min & Typ & T5 \\ \hline Min & T5 \\ \hline \ Min & T5 \\ \hline \$	$\begin{tabular}{ c c c c c } \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline Min & Typ & Max & Max \\ \hline \ See Figure 5 & 11 & -1 & 130 & 165 \\ \hline V_{CC} = 4.5 V & -1 & 15 & 26 & 33 \\ \hline V_{CC} = 6.0 V & -1 & 12 & -2 & -1 \\ \hline V_{CC} = 6.0 V & -1 & 12 & 22 & 28 \\ \hline \ Min & Typ & Max & Max \\ \hline \ V_{CC} = 4.5 V & -1 & 15 & 19 \\ \hline \ V_{CC} = 4.5 V & -1 & 7 & 15 & 19 \\ \hline \end{tabular}$	$\begin{tabular}{ c c c c c c } \hline Min & Typ & Max & M$

Symbol	Parameter	Conditions			25 °C		–40 °C to	o +125 ℃	Unit
				Min	Тур	Max	Мах (85 °С)	Max (125 °C)	
C <sub>PD</sub>	power dissipation capacitance	per package; $V_I = GND$ to $V_{CC}$	<u>[3]</u>	-	15	-	-	-	pF
74HCT30	)	L							
t <sub>pd</sub>	propagation delay	A, B, C, D, E, F, G, H to Y; see <u>Figure 5</u>	<u>[1]</u>						
		V <sub>CC</sub> = 4.5 V		-	16	28	35	42	ns
		V <sub>CC</sub> = 5.0 V; C <sub>L</sub> = 15 pF		-	12	-	-	-	ns
t <sub>t</sub>	transition time	$V_{CC} = 4.5 \text{ V}; \text{ see } \frac{\text{Figure 5}}{1000}$	[2]	-	7	15	19	22	ns
C <sub>PD</sub>	power dissipation capacitance	per package; V <sub>I</sub> = GND to V <sub>CC</sub> – 1.5 V	<u>[3]</u>	-	15	-	-	-	pF

#### **Table 7. Dynamic characteristics** ... continued GND = 0 V: $C_{1} = 50$ pE: for test circuit see Figure 6

[1]  $t_{pd}$  is the same as  $t_{PHL}$  and  $t_{PLH}$ .

[2]  $t_t$  is the same as  $t_{THL}$  and  $t_{TLH}$ .

[3]  $C_{PD}$  is used to determine the dynamic power dissipation (P<sub>D</sub> in  $\mu$ W):

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$  where:

 $f_i$  = input frequency in MHz;

 $f_o$  = output frequency in MHz;

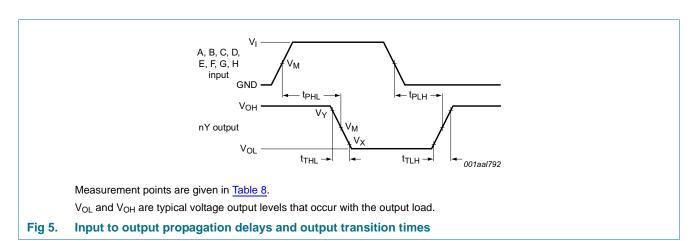
 $C_L$  = output load capacitance in pF;

 $V_{CC}$  = supply voltage in V;

N = number of inputs switching;

 $\sum (C_L \times V_{CC}^2 \times f_o)$  = sum of outputs.

### 11. Waveforms



#### Table 8. Measurement points

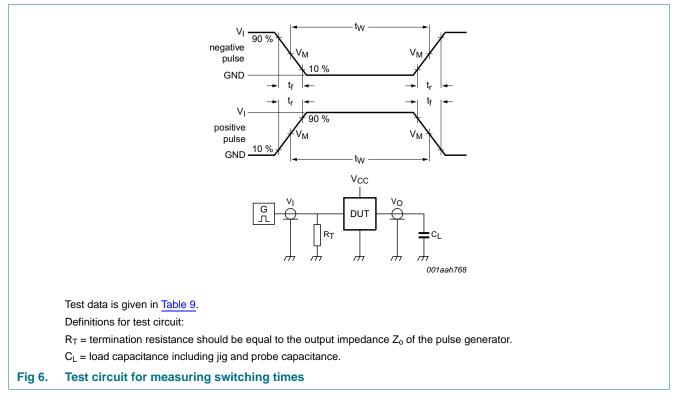
Туре	Input	Output					
	V <sub>M</sub>	V <sub>M</sub>	V <sub>X</sub>	V <sub>Y</sub>			
74HC30	0.5V <sub>CC</sub>	0.5V <sub>CC</sub>	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>			
74HCT30	1.3 V	1.3 V	0.1V <sub>CC</sub>	0.9V <sub>CC</sub>			

74HC\_HCT30 Product data sheet

### Nexperia

# 74HC30; 74HCT30

### 8-input NAND gate

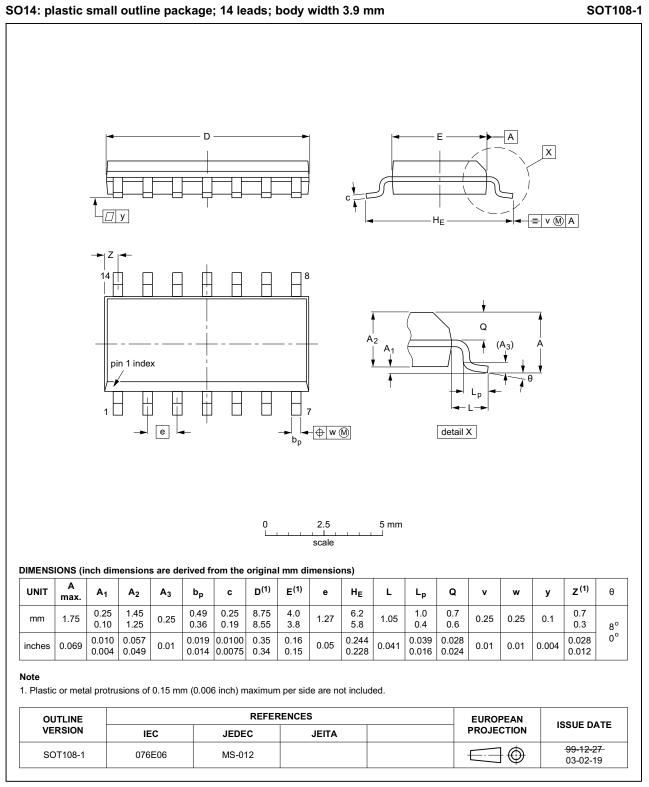


#### Table 9. Test data

Туре	Input L		Load	Test
	VI	t <sub>r</sub> , t <sub>f</sub>	CL	
74HC30	V <sub>CC</sub>	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>
74HCT30	3.0 V	6.0 ns	15 pF, 50 pF	t <sub>PLH</sub> , t <sub>PHL</sub>

8-input NAND gate

### 12. Package outline



#### Fig 7. Package outline SOT108-1 (SO14)

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74HC\_HCT30

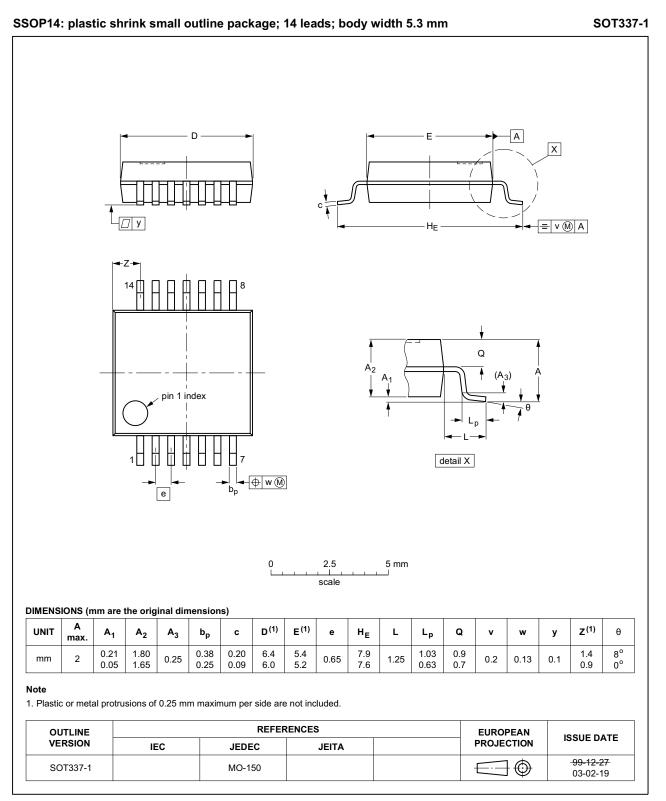
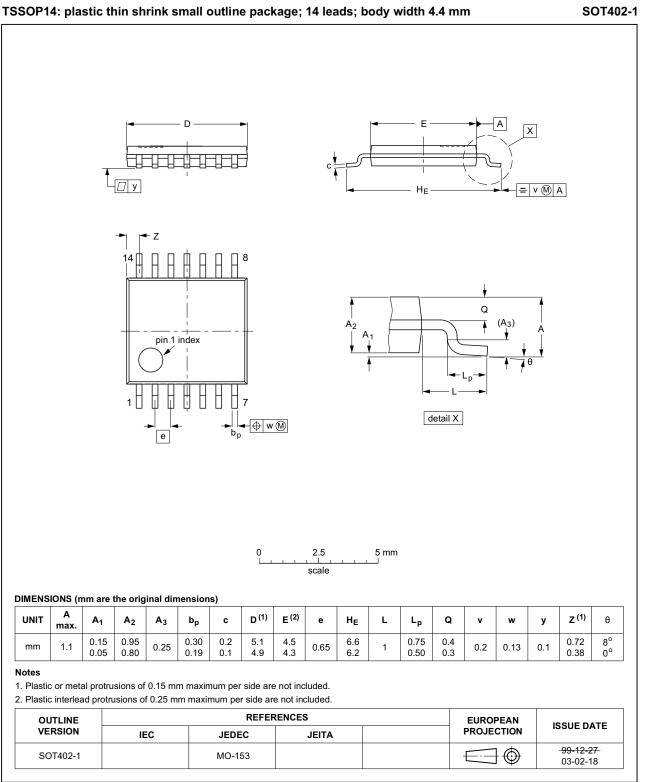


Fig 8. Package outline SOT337-1 (SSOP14)

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74HC\_HCT30



Package outline SOT402-1 (TSSOP14) Fig 9.

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74HC\_HCT30

## **13. Abbreviations**

Table 10.     Abbreviations					
Acronym	Description				
CMOS	Complementary Metal-Oxide Semiconductor				
DUT	Device Under Test				
ESD	ElectroStatic Discharge				
НВМ	Human Body Model				
MM	Machine Model				
TTL	Transistor-Transistor Logic				

## 14. Revision history

### Table 11. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
74HC_HCT30 v.7	20151202	Product data sheet	-	74HC_HCT30 v.6
Modifications:	<ul> <li>Type numbers 74HC30N and 74HCT30N (SOT27-1) removed.</li> </ul>			
74HC_HCT30 v.6	20121227	Product data sheet	-	74HC_HCT30 v.5
Modifications:	New general description.			
74HC_HCT30 v.5	20111213	Product data sheet	-	74HC_HCT30 v.4
Modifications:	Legal pages updated.			
74HC_HCT30 v.4	20100504	Product data sheet	-	74HC_HCT30 v.3
74HC_HCT30 v.3	20100420	Product data sheet	-	74HC_HCT30 v.2
74HC_HCT30 v.2	19970829	Product specification	-	-

### **15. Legal information**

### 15.1 Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nexperia.com">http://www.nexperia.com</a>.

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#### Nexperia

# 74HC30; 74HCT30

#### 8-input NAND gate

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